

Vishay Siliconix

P-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY						
V _{DS} (V)	-30					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -10 \text{ V}$	0.0079					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5 \text{ V}$	0.0108					
Q _g typ. (nC)	44					
I _D (A)	-16 ^{a, e}					
Configuration	Single					

FEATURES

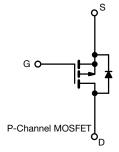
- TrenchFET® Gen III p-channel power MOSFET
- 100% R_g tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Adapter switch
- · Load switch
- Power management in battery-operated, mobile and wearable devices



ORDERING INFORMATION	
Package	SO-8
Lead (Pb)-free and halogen-free	Si4103DY-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	-30	V
Gate-source voltage		V _{GS}	± 20	V
	T _C = 25 °C		-16 ^a	
Continuous dusin surrent /T 150 °C)	T _C = 70 °C		-16 ^a	
Continuous drain current (T _J = 150 °C)	T _A =25 °C	I _D	-14 ^{b, c}	
	T _A = 70 °C		-11.3 ^{b, c}	А
Pulsed drain current (t = 100 µs)		I _{DM}	-80 ^a	
Continuous source-drain diode current	T _C = 25 °C	,	-4.3	
	T _A = 70 °C	I _S	-2.1 ^{b, c}	
Maximum power dissipation	T _C = 25 °C		5.2	
	T _C = 70 °C		3.3	14/
	T _A = 25 °C	P _D	2.5 b, c	W
	T _A = 70 °C		1.6 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	**
Soldering recommendations (peak temperature)			260	°C

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum junction-to-ambient b, d	t ≤ 10 s	R _{thJA}	40	50	°C/W		
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	20	24	C/VV		

Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. Maximum under steady state conditions is 85 °C/W
- e. $T_C = 25$ °C



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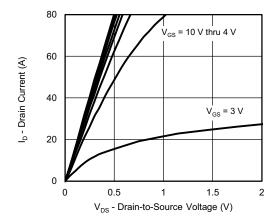
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	•		I.		•	·	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	-23	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	5	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1	-	-2	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zana alian alla andre la const		V _{DS} = -30 V, V _{GS} = 0 V	-	-			
Zero gate voltage drain current	I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	-10	μA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = 0 \text{ V}$	-5	-	-	Α	
5		$V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$	-	0.0067	0.0079	Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$	-	0.0090	0.0108		
Forward transconductance a	9 _{fs}	$V_{DS} = -10 \text{ V}, I_D = -20 \text{ A}$	-	60	-	S	
Dynamic ^b	•		I.	1	•	ı	
Input capacitance	C _{iss}		-	5200	-	pF	
Output capacitance	C _{oss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	535	-		
Reverse transfer capacitance	C _{rss}		-	470	-		
Total gate charge	Q_g	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$	-	92	140		
		$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -10 \text{ A}$	-	44	66		
Gate-source charge	Q_{gs}	V 45VV 45VI 40A	-	12.1	-	nC	
Gate-drain charge	Q _{qd}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -10 \text{ A}$	-	14.8	-	1	
Gate resistance	R_g	f = 1 MHz	0.8	3.8	7.6	Ω	
Turn-on delay time	t _{d(on)}		-	57	120		
Rise time	t _r	$V_{DD} = -15 \text{ V}, R_L = 3 \Omega, I_D \cong -5 \text{ A},$	_	38	80		
Turn-off delay time	t _{d(off)}	V_{GEN} = -4.5 V, R_g = 1 Ω	-	55	110		
Fall time	t _f		-	28	60		
Turn-on delay time	t _{d(on)}		-	11	20	ns	
Rise time	t _r	V_{DD} = -15 V, R_L = 3 Ω , $I_D \cong$ -5 A,	-	17	35		
Turn-off delay time	t _{d(off)}	V_{GEN} = -10 V, R_g = 1 Ω	_	78	160		
Fall time	t _f		_	26	50		
Drain-Source Body Diode Characteristi	cs				•		
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	-4.3	۸	
Pulse diode forward current	I _{SM}		-	-	-80	A	
Body diode voltage	V_{SD}	I _S = -5 A, V _{GS} = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	31	60	ns	
Body diode reverse recovery charge	Q _{rr}		-	20	40	nC	
Reverse recovery fall time	ta	$I_F = -5 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$	-	13	-		
Reverse recovery rise time	t _b		-	18	_	ns	

Notes

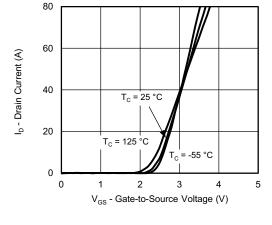
- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

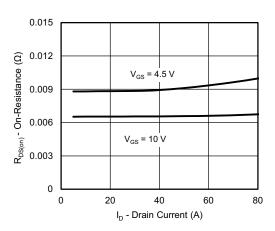




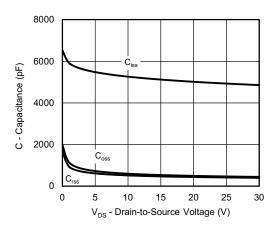
Output Characteristics



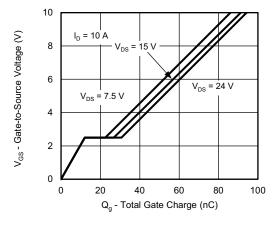
Transfer Characteristics



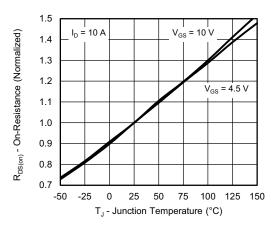
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

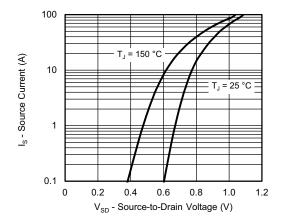


Gate Charge

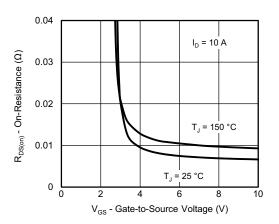


On-Resistance vs. Junction Temperature

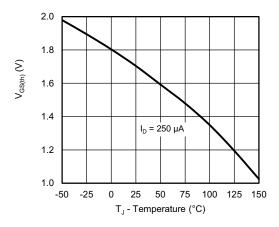




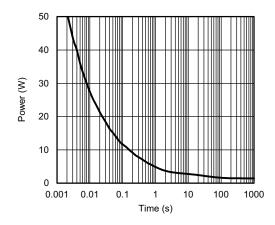
Source-Drain Diode Forward Voltage



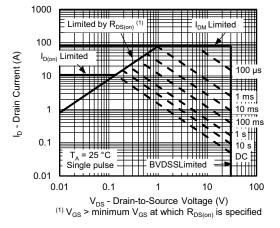
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

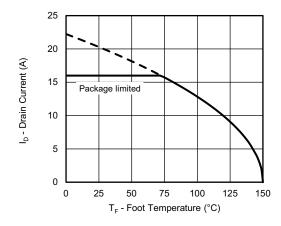


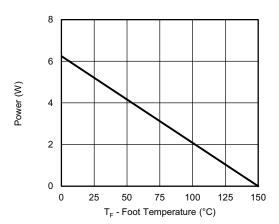
Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient







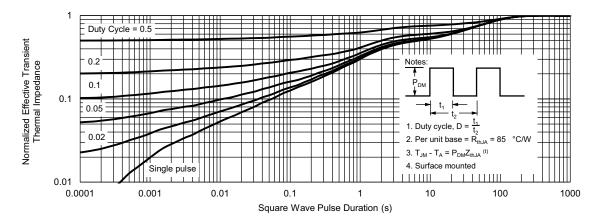
Current Derating a

Power, Junction-to-Foot

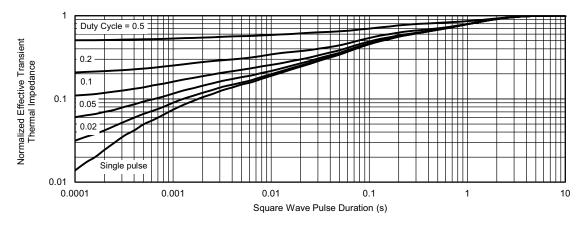
Note

a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



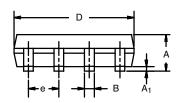
Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?75972.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
FCN: C-06527-Bey 11-Sen-06					

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06 www.vishay.com



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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